

Evaluating the ADGM1144 0 Hz/DC to 18 GHz, SP4T, MEMS Switch

FEATURES

- ▶ Single-supply voltage: 3.3 V
- ▶ Wide frequency range: DC to 18 GHz
- ▶ SMA connectors for RF signals
- ▶ Parallel interface and SPI
- ▶ On-board calibration thru transmission line for analyzer calibration

EVALUATION KIT CONTENTS

- ▶ EVAL-ADGM1144SDZ evaluation board

ADDITIONAL EQUIPMENT NEEDED

- ▶ 3.3 V DC power supply
- ▶ Vector network analyzer (VNA)
- ▶ [EVAL-SDP-CB1Z \(SDP-B\)](#) controller board
- ▶ [Analysis | Control | Evaluation \(ACE\) Software](#) with EVAL-ADGM1144SDZ plugin

GENERAL DESCRIPTION

This user guide describes the EVAL-ADGM1144SDZ for the [ADGM1144](#), a dual-chip, RF switching solution containing a single-pole, four-throw (SP4T), microelectromechanical systems (MEMS) switch, and a control chip copackaged in a compact, 5.00 mm × 4.00 mm × 1.0 mm, LGA package.

The SP4T switch uses Analog Devices, Inc., MEMS switch technology, providing optimum performance in terms of bandwidth, power handling capability, and linearity for RF applications. The control chip generates the high-voltage signals needed for the MEMS switch and allows the user to control its operation through a simple and flexible complementary metal-oxide semiconductor (CMOS)/low voltage transistor to transistor logic (LVTTTL)-compliant parallel-interface as well as through a serial-peripheral interface (SPI). It is possible to daisy-chain multiple ADGM1144 devices together to enable the configuration of multiple devices with a minimal number of digital lines.

For SPI, the EVAL-ADGM1144SDZ connects to the USB port of a PC via the SDP board. The EVAL-SDP-CB1Z board (SDP-B controller board) is available to order at the Analog Devices website.

The EVAL-ADGM1144SDZ comes fitted with connectors for RF and control signals as well as links to control the operation of the switch and evaluate its performance.

For full details on the ADGM1144, see the ADGM1144 data sheet, which must be consulted in conjunction with this user guide when using the EVAL-ADGM1144SDZ.

EVAL-ADGM1144SDZ PHOTOGRAPH

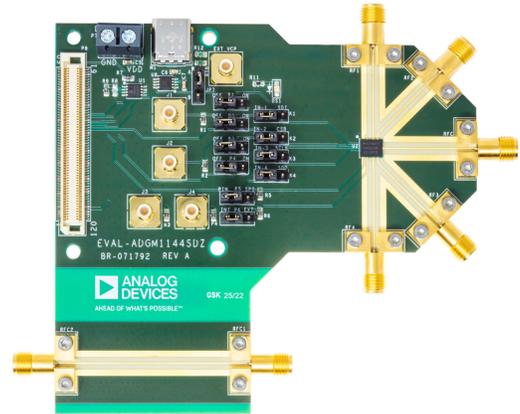


Figure 1.

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REVISION HISTORY

6/2025—Rev. 0 to Rev. A

Changes to Table 8.....	18
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10/2022—Revision 0: Initial Version

EVALUATION BOARD HARDWARE

The EVAL-ADGM1144SDZ evaluation kit contains a fully fitted printed circuit board (PCB).

The EVAL-ADGM1144SDZ allows the user to connect RF signals to the MEMS switch. The user controls the switch operation using the on-board links or by applying the correct control signals to the appropriate connectors.

The EVAL-ADGM1144SDZ provides an additional transmission line to facilitate the calibration of the network analyzer to minimize the effects of the PCB tracks that connect the RF signals to the MEMS switch. See the [Network Analyzer Calibration Procedure](#) section for more information on the calibration process.

POWER SUPPLY

To operate the EVAL-ADGM1144SDZ, the user must provide an external power supply either through a Mini-USB connector (M1) or through the power block (P7). When JP7 is in the A position, the EVAL-ADGM1144SDZ is powered by the Mini-USB connector, and when JP7 is in the B position, the EVAL-ADGM1144SDZ is powered by the external 3.3 V power supply through the power block (see [Table 1](#)). The power-supply voltage required for the EVAL-ADGM1144SDZ is 3.3 V, and it must be positive with respect to the ground of the EVAL-ADGM1144SDZ. The ground of the EVAL-ADGM1144SDZ is marked with GND on the silkscreen (see [Figure 24](#)).

Table 1. JP7 Link Position

Position	Power Supply Selection
A	EVAL-ADGM1144SDZ powered by the Mini-USB
B	EVAL-ADGM1144SDZ powered by the external 3.3 V power supply

RF CONNECTORS

The 3.5 mm end launch connectors on the EVAL-ADGM1144SDZ (RF1, RF2, RF3, RF4, and RFC) connect to each switch in the [ADGM1144](#) for performance evaluation purposes. The RFC1 and RFC2 connectors connect to a transmission line to estimate the loss associated with the PCB (see the [Measuring Switch Performance](#) section). [Table 2](#) describes the RF connectors to the ADGM1144.

Table 5. Link Settings (Per PCB Label) for Parallel-Interface Use (See [Figure 7](#))

Controlled RF Switch	RF Switch Status	Link Name	Link Position
RF1 to RFC	Off	P1	Off (default)
	On	K1	IN-1 (default)
RF2 to RFC	Off	P1	On
		K1	IN-1
	On	P2	Off (default)
		K2	IN-2 (default)
Off	P2	On	
	K2	IN-2	

Table 2. Connecting the RF Connectors to the ADGM1144

Connector	Description
RF1	Port RF1 of the ADGM1144
RF2	Port RF2 of the ADGM1144
RF3	Port RF3 of the ADGM1144
RF4	Port RF4 of the ADGM1144
RFC	Common RF port of the ADGM1144
RFC1, RFC2	Calibration thru transmission lines used for calibration

SWITCH CONTROL CONNECTORS

The ADGM1144 comes with a standard LVTTTL parallel-interface consisting of four input pins (IN1, IN2, IN3, and IN4) controlled by the P1, P2, P3, and P4 links. See [Table 5](#) for more details on the logic control when using the parallel-interface.

The ADGM1144 also has an SPI that can be controlled by the K1 to K4 links. When the P5 link is set to the PIN position, the SPI is enabled. When the P5 link is set to the SPI position, the parallel-interface is enabled (see [Table 3](#)).

Table 3. P5 Link Position

Position	Reference Clock Setting
SPI (Default)	Parallel-interface enabled
PIN	SPI enabled, parallel-interface disabled

The control IC packaged with the MEMS switch internally generates the voltage required to drive the switch. The internal control IC contains a reference clock signal at a nominal 10 MHz. In normal operation, set the P6 link to INT, enabling the built-in 10 MHz oscillator to enable the internal driver IC voltage boost circuitry (see [Table 4](#)). Set the P6 link to EXT to disable the internal 10 MHz oscillator and drive the VCP pin with 80 V DC from the external voltage supply. The VCP pin is connected to the EXT_VCP Subminiature Version B (SMB) connector on the EVAL-ADGM1144SDZ, which can be used for applying 80 V DC to the external voltage supply. Disabling the internal oscillator eliminates the associated 10 MHz noise feedthrough into the switch. With the oscillator disabled, the logic interface pins (P1 to P4) still control the switch.

Table 4. P6 Link Position

Position	Reference Clock Setting
INT (Default)	Built-in 10 MHz oscillator enable
EXT	Disables the internal oscillator

EVALUATION BOARD HARDWARE

Table 5. Link Settings (Per PCB Label) for Parallel-Interface Use (See [Figure 7](#)) (Continued)

Controlled RF Switch	RF Switch Status	Link Name	Link Position
RF3 to RFC	Off	P3	Off (default)
		K3	IN-3 (default)
	On	P3	On
		K3	IN-3
RF4 to RFC	Off	P4	Off (default)
		K4	IN-4 (default)
	On	P4	On
		K4	IN-4

EVALUATION BOARD SOFTWARE FOR THE SPI

INSTALLING THE SOFTWARE

The EVAL-ADGM1144SDZ uses the Analog Devices ACE software. ACE is a desktop software application that allows the evaluation and control of multiple evaluation systems.

The ACE software installer installs the necessary SDP drivers and .NET Framework 4 by default. Install the ACE software before connecting the SDP driver. The ACE software and access to full instructions on how to install and use the ACE software can be found on the Analog Devices website.

After the installation completes, the EVAL-ADGM1144SDZ plugins appear when opening the ACE software.

INITIAL SETUP

To set up the EVAL-ADGM1144SDZ, complete the following steps:

1. Change the position of the K1 through the K4 links to SDI, \overline{CS} , SCLK, and SDO, respectively.
2. Change the position of the P1 through the P4 links to the off position.
3. Change the P5 link position from PIN to SPI and keep the P6 link position at INT.
4. Connect the EVAL-ADGM1144SDZ to the SDP board and connect the SDP board to the computer via a USB cable.
5. Power the EVAL-ADGM1144SDZ as described in the [Power Supply](#) section.
6. Run the ACE software. The EVAL-ADGM1144SDZ plugins appear in the **Attached Hardware** window of the **Start** tab (see [Figure 2](#)).
7. Double-click the EVAL-ADGM1144SDZ plug-ins to open the evaluation board view in [Figure 3](#).
8. The chip block diagram can be accessed by double-clicking the **ADGM1144** chip (see [Figure 3](#)). The view after clicking the **ADGM1144** chip provides a basic representation of functionality of the EVAL-ADGM1144SDZ. The main functions are labeled in [Figure 4](#).

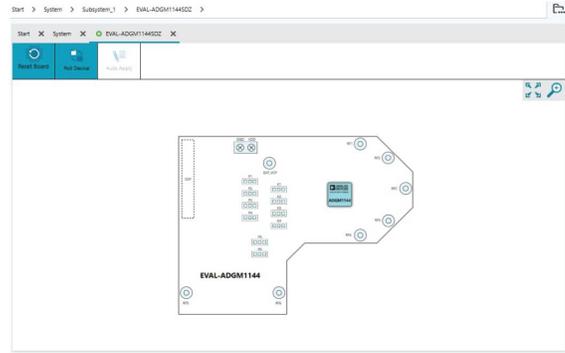


Figure 3. Evaluation Board View of the EVAL-ADGM1144SDZ

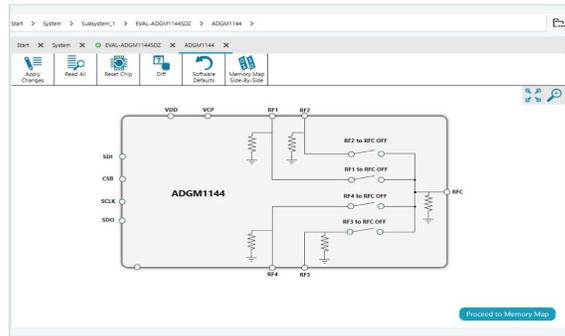


Figure 4. Chip Block Diagram View for the ADGM1144

Table 6. SPI Interface Links Description

Links	Position	Description
K1	SDI	Serial data Input pin
K2	\overline{CS}	Chip select pin
K3	SCLK	Clock input pin
K4	SDO	Serial data output pin

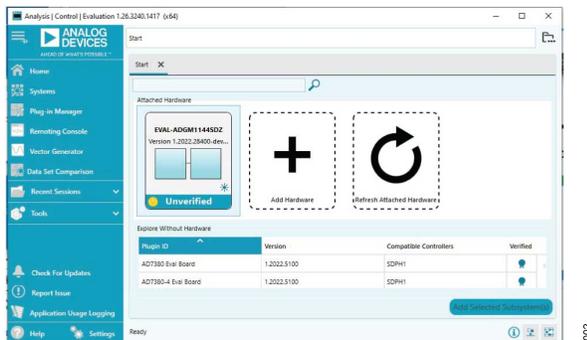


Figure 2. EVAL-ADGM1144SDZ Plugin Start-Up Window

EVAL-ADGM1144SDZ BLOCK DIAGRAM AND DESCRIPTIONS

The EVAL-ADGM1144SDZ software is organized so that it appears similar to the functional block diagram shown in the [ADGM1144](#) data sheet.. A full description of each block and register, as well as their respective settings, are given in the ADGM1144 data sheet.

Some of the blocks and their functions are described in [Table 7](#) because these blocks pertain to the EVAL-ADGM1144SDZ. The full screen block diagram, shown in [Figure 5](#), describes the functionality of each block.

All changes to the blocks correspond to the block diagram in the software. For example, if the internal register bit is enabled, it displays as enabled on the block diagram. If any bits or registers have modified values that have not been transferred to the EVAL-ADGM1144SDZ, they appear in bold in [Figure 5](#). After clicking **Apply Changes**, the data is transferred to the EVAL-ADGM1144SDZ.

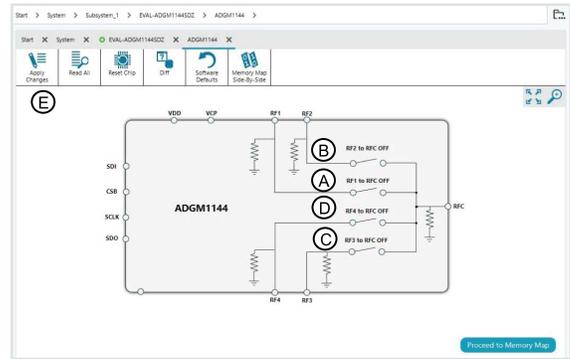


Figure 5. EVAL-ADGM1144SDZ Block Diagram with Labels

Table 7. EVAL-ADGM1144SDZ Block Diagram Function Descriptions (See [Figure 5](#))

Label	Function Description
A	Click the switch symbol to open and close the RF1 to RFC switch
B	Click the switch symbol to open and close the RF2 to RFC switch
C	Click the switch symbol to open and close the RF3 to RFC switch
D	Click the switch symbol to open and close the RF4 to RFC switch
E	Click Apply Changes to apply all the modified values to the devices

EVAL-ADGM1144SDZ BLOCK DIAGRAM AND DESCRIPTIONS

MEMORY MAP

Click **Proceed to Memory Map** for full accessibility to all of the registers (see [Figure 5](#)). This access allows registers to be edited at a bit level (see [Figure 6](#)). The bits shaded in dark gray in [Figure 6](#) are read only bits and cannot be accessed from **ACE**, and all other bits are toggled. Clicking the **Apply Changes** button transfers data to the **ADGM1144**.

All changes made in the memory map correspond to the block diagram. For example, if the internal register bit is enabled, the bit displays as enabled in the block diagram. Any bits or registers that are bold in [Figure 6](#) are modified values that have not been transferred to the EVAL-ADGM1144SDZ. Click **Apply Changes** to transfer data to the EVAL-ADGM1144SDZ.

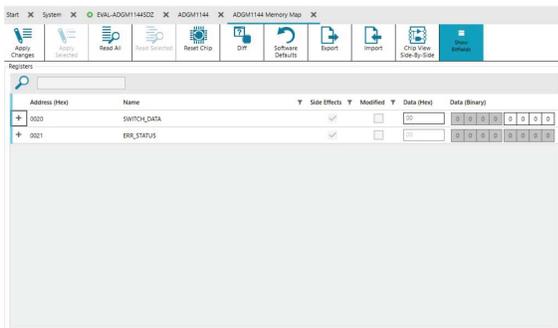


Figure 6. ADGM1144 Memory Map

MEASURING SWITCH PERFORMANCE

Figure 7 shows the connection diagram of the EVAL-ADGM1144SDZ in parallel-interface. Apply a V_{DD} supply to the EVAL-ADGM1144SDZ to measure the performance of the switch. The links are set according to the switch under test (see Table 6). After selecting the desired channel and its state, the switch performance data can be collected using a network analyzer. Terminate the RFX edge connectors of the unused switch channels into 50 Ω loads to achieve the full performance of the channel under test.

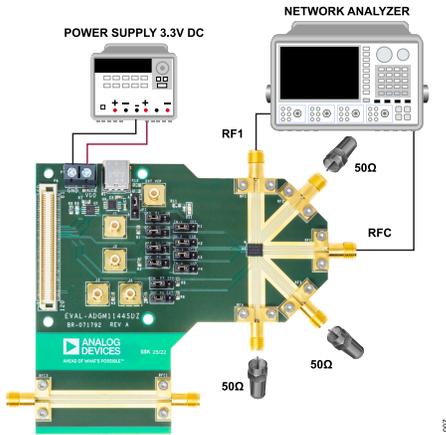


Figure 7. EVAL-ADGM1144SDZ Connection Diagram for Parallel-Interface

The EVAL-ADGM1144SDZ, shown in Figure 7, comes with a calibration transmission line, calibration thru, on the PCB. This calibration line removes the insertion loss and phase offset of the PCB transmission lines connecting to the switch from the measurement. Figure 8 shows the calibration transmission line and Figure 9 shows its insertion loss and return loss up to 20 GHz. The calibration line is exactly the same length as the distance from any one RFX connector to the RFX pin of the ADGM1144 plus the distance from the RFC connector to the RFC pin of the ADGM1144.

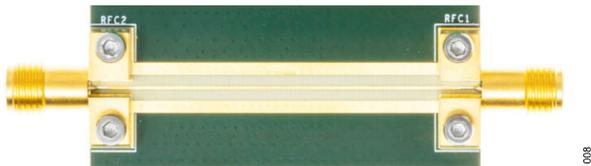


Figure 8. EVAL-ADGM1144SDZ Calibration Transmission Line Used for PCB Insertion Loss and Phase Offset Correction

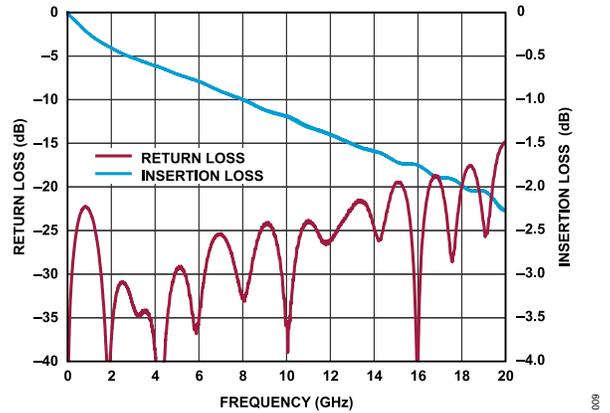


Figure 9. Calibration Transmission Line Insertion Loss and Return Loss

Figure 10 shows the calibration line length. All RF traces connecting to the ADGM1144 are of equal length.

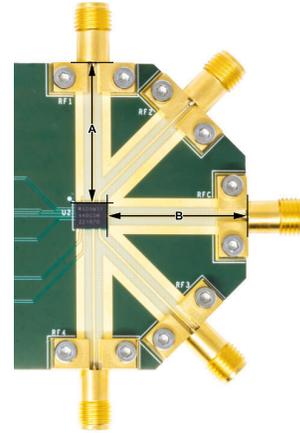


Figure 10. Calibration Transmission Line Length Equal to the A + B Length

To de-embed the PCB transmission line insertion loss from the entire switch insertion loss board measurement (the RF1 to RFC path), divide the $S(2,1)$ insertion loss of the measured data by the $|S(2,1)|$ of the calibration thru line. Perform this de-embedding by using the network analyzer at the time of the measurement or after the measurement using individual measurement data files. Refer to the Network Analyzer Calibration Procedure section for more information.

Use the network analyzer port extension function to de-embed any phase offset introduced by the PCB transmission lines. The port extension method uses time delay offset values to correct for phase. Enter the time delays into the port extension menu on the network analyzer corresponding to any phase offset introduced from an RF edge connector to the switch pin. Figure 10 shows an example of these phase offsets on a typical switch measurement, labeled as A and B. Both A and B are identical in length and can be calculated by measuring the time delay of the calibration line and dividing it by two.

MEASURING SWITCH PERFORMANCE

Figure 11 shows the ADGM1144 switch insertion loss measurement results of all four channels that are de-embedded with respect to the PCB transmission line losses.

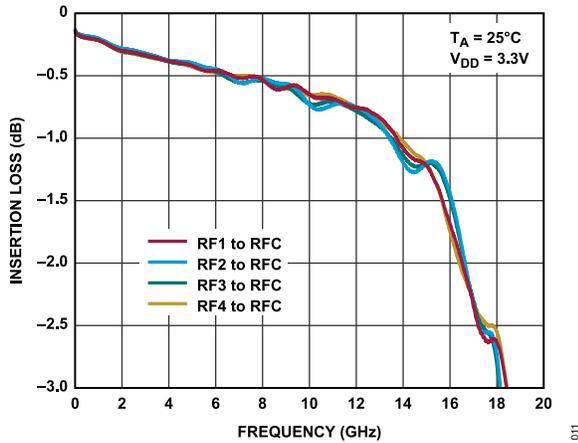


Figure 11. PCB De-Embedded ADGM1144 Insertion Loss Performance

Figure 12 shows the ADGM1144 switch return loss performance measurement results for all four channels.

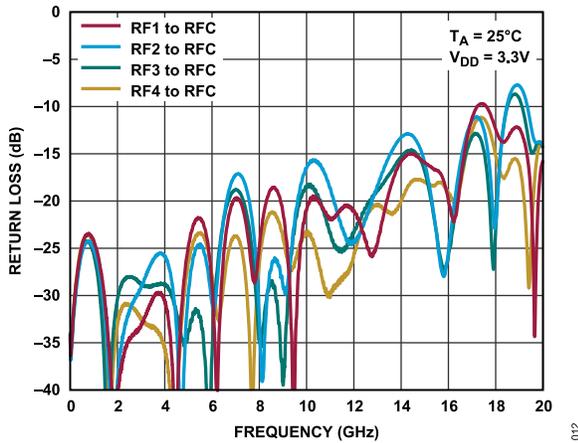


Figure 12. ADGM1144 Return Loss Performance

Figure 13 shows the ADGM1144 switch off isolation performance measurement results for all four channels.

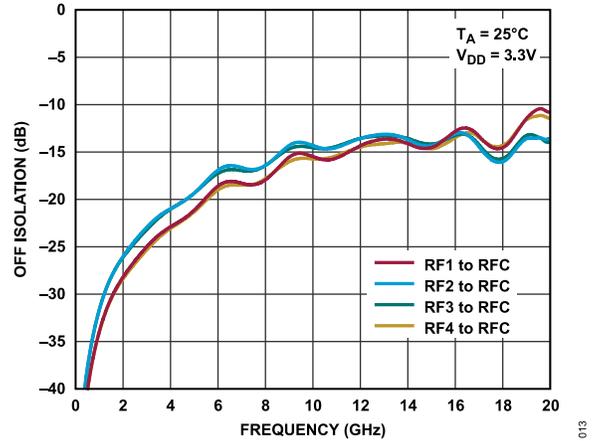


Figure 13. ADGM1144 Off-Isolation Performance

NETWORK ANALYZER CALIBRATION PROCEDURE

Use the following procedure in conjunction with the EVAL-ADGM1144SDZ for two-port measurements, assuming the user has a set of manual calibration standards or an electric calibration type unit to perform a short load open through (SLOT) calibration of the network analyzer. The maximum value for the network analyzer frequency sweep for the EVAL-ADGM1144SDZ PCB can be up to 20 GHz. Perform the following steps for the two-port measurements:

1. Perform a full, two-port standard SLOT calibration of the network analyzer.
2. Connect the calibration thru calibration line (Connector RFC1 and Connector RFC2) to the analyzer and measure its insertion loss, $S(2,1)$.
3. Save the measured data to the network analyzer memory for later use.
4. Configure the EVAL-ADGM1144SDZ links and power up the EVAL-ADGM1144SDZ with a 3.3 V DC power supply.
5. Connect the network analyzer to the desired MEMS switch RF connectors and apply the external control signals, if needed.
6. Measure the complete insertion loss of the EVAL-ADGM1144SDZ. Include the insertion loss of the MEMS switch and test fixture (PCB transmission lines and RF connectors).
7. De-embed the PCB losses from the complete evaluation board measurement using the data saved at Step 3 and the measured data at Step 6. Because the extraction method is dependent on the network analyzer, consult the network analyzer user manual before performing the extraction. Typically, the divide function divides the complete $S(2,1)$ insertion loss measurement data by the calibration thru line $S(2,1)$ insertion loss data stored in memory.
8. Use the network analyzer port extension function to de-embed the phase offset introduced by the PCB transmission lines. The port extension method uses time delay offset values to correct for phase. Enter the time delay values into the port extension menu on the network analyzer for each RF edged connector to switch the pin path equal to the electrical length of the calibration line divided by two.

HANDLING GUIDELINES

Adhere to the following handling guidelines for the EVAL-ADGM1144SDZ:

- ▶ Always treat the [ADGM1144](#) as a static sensitive device and observe normal handling precautions, including working only on static dissipative surfaces, wearing wrist straps, or other electrostatic discharge (ESD) control devices.
- ▶ Take care when connecting signals. Hold the EVAL-ADGM1144SDZ from the edges to avoid any damage to the device under test (DUT).
- ▶ Avoid connecting live signal sources. Ensure that outputs are switched off (preferably grounded) before connecting to the DUT. In addition, ensure all instrumentation shares a common chassis ground.
- ▶ Avoid running measurement instruments (for example, digital multimeters (DMMs) in autorange modes). Some instruments can generate large transient compliance voltages when switching ranges.
- ▶ Use the highest practical range (that is, lowest resolution) setting for resistance measurements to minimize compliance voltages.

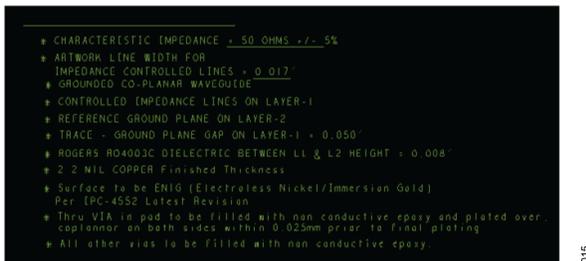
LAYOUT RECOMMENDATIONS

The EVAL-ADGM1144SDZ is a 4-layer board. The EVAL-ADGM1144SDZ uses 8 mil Roger RO4003C dielectric. The outer copper layers have 2.2 mil finish thickness with electroless nickel immersion gold (ENIG) finish. The RF transmission lines were designed using a micro strip model with a width of 17 mil and ground spacing of 50 mil to have a characteristic impedance of 50 Ω (see [Figure 14](#) and [Figure 15](#)). It is recommended to use plenty of vias under the [ADGM1144](#) and along the RF traces to provide good grounding and to avoid any resonance at high frequencies. To achieve optimum RF performance, Rosenberger right angle jack connectors (32K243-40ML5) are used.



014

Figure 14. EVAL-ADGM1144SDZ Board Stackup



015

Figure 15. EVAL-ADGM1144SDZ Additional Board Manufacturing Information

SOLDERING RECOMMENDATIONS

To avoid solder voids under the [ADGM1144](#), it is recommended to use a 0.0767 mm (3 mil) thick solder stencil with nano coating. The aperture size for the solder stencil must be 1:1, and divide the paste mask with multiple pads, as shown in [Figure 16](#). Poor soldering may impact the RF performance of the ADGM1144.

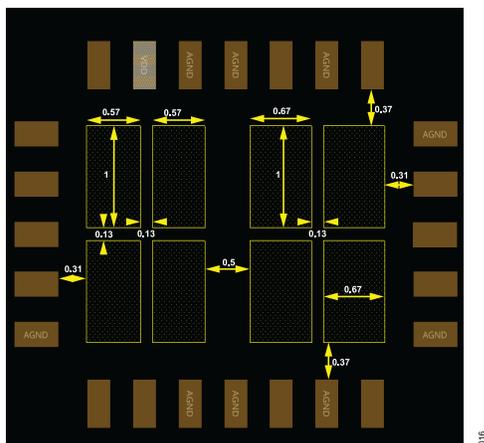


Figure 16. Solder Stencil Recommendations in Millimeters

EVALUATION BOARD SCHEMATICS AND ARTWORK

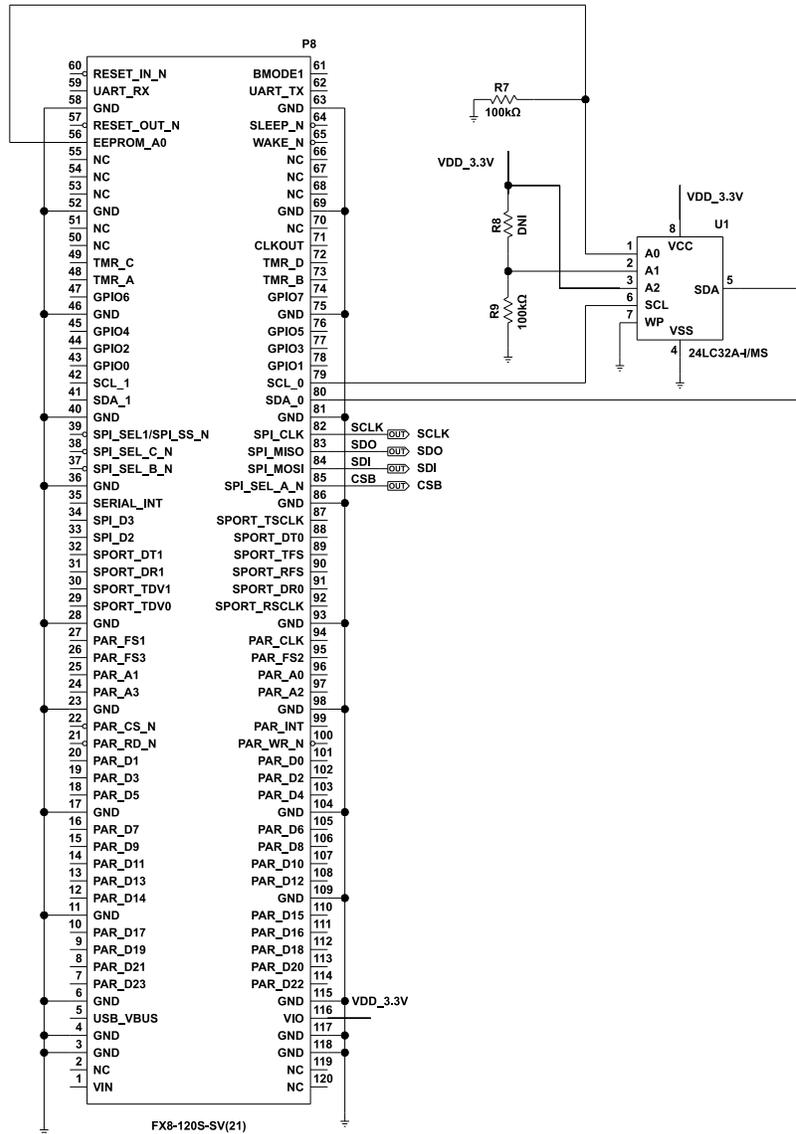


Figure 18. Schematic of the EVAL-ADGM1144SDZ with an SDP Connector

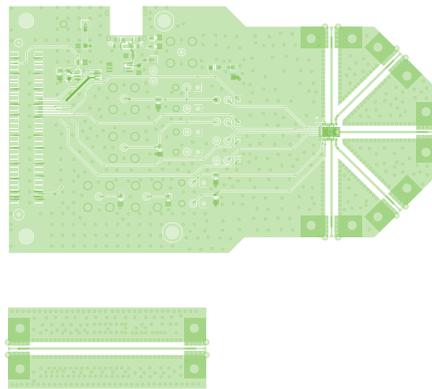
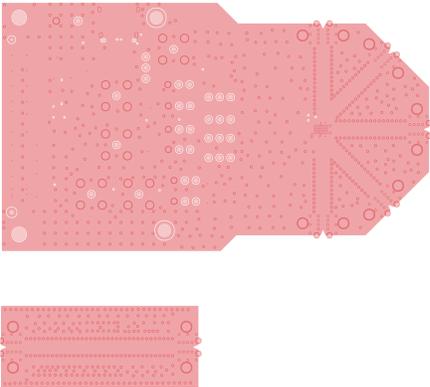


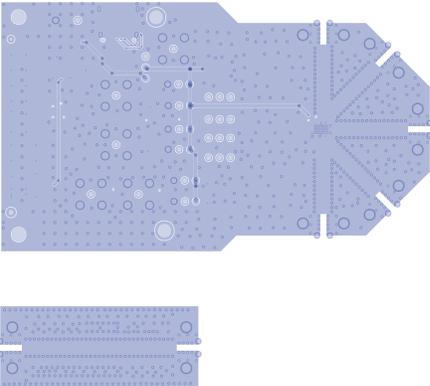
Figure 19. EVAL-ADGM1144SDZ Component Side PCB Drawing (Layer 1)

EVALUATION BOARD SCHEMATICS AND ARTWORK



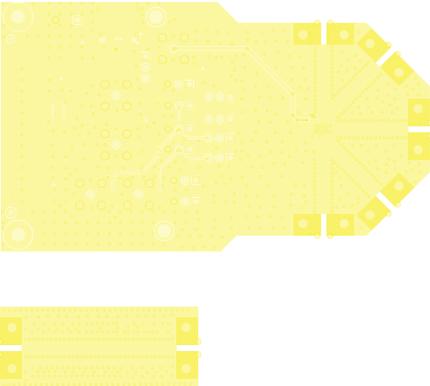
020

Figure 20. EVAL- ADGM1144SDZ Component Side Ground Plane PCB Drawing (Layer 2)



021

Figure 21. EVAL- ADGM1144SDZ Component Side Ground Plane PCB Drawing (Layer 3)



022

Figure 22. EVAL- ADGM1144SDZ Component Side, Bottom Side PCB Drawing (Layer 4)

EVALUATION BOARD SCHEMATICS AND ARTWORK

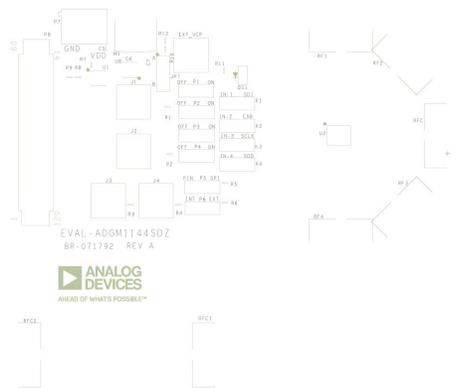


Figure 23. EVAL-ADGM1144SDZ Component Side Silkscreen PCB Drawing (Top)

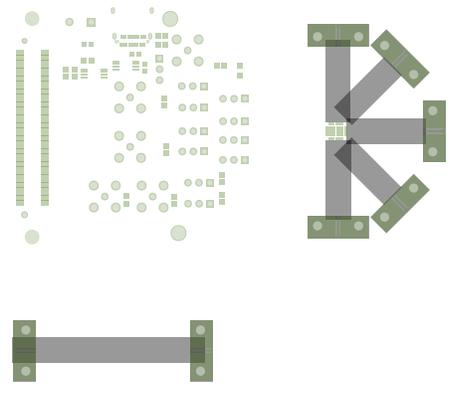


Figure 24. EVAL-ADGM1144SDZ Soldermask Top

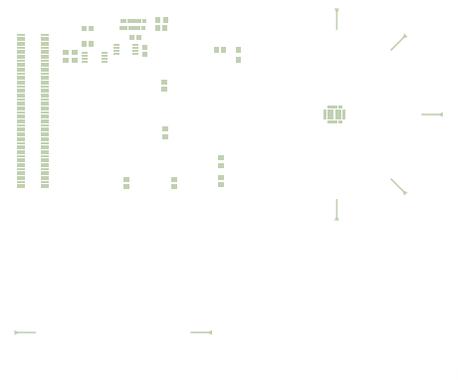


Figure 25. EVAL-ADGM1144SDZ Paste Top

ORDERING INFORMATION

BILL OF MATERIALS

Table 8.

Reference Designator	Description	Manufacturer	Manufacturer Number
C5	10 μ F ceramic capacitor, 10 V, 20%, X5R, 0603, low effective series resistance (ESR)	TDK	C1608X5R1A106M080AC
C6, C7	1 μ F ceramic capacitors, 16 V, 10%, X7R, 0603	AVX	0603YC105KAT2A
DS1	630 nm light emitting diode (LED), surface-mount device (SMD), red	Broadcom Limited	HSMS-C170
EXT_VCP, J1 to J4	PCB connectors, Subminiature Version B (SMB), coaxial straight jack	Amphenol	SMB1251B1-3GT30G-50
M1	PCB connector, USB connector USB Type C	Amphenol	12401598E4#2A
JP7, K1 to K4, P1 to P6	PCB connectors, 3-position, male header, unshrouded single row, 2.54 mm pitch, 3 mm solder tail	Harwin	M20-9990345
P7	2-pin terminal block (5 mm pitch)	Lumberg	KRM 02
P8	120-way, 0.6 mm pitch, 2 row straight PCB connector	HRS	FX8-120S-SV(21)
R1 to R6	10 k Ω resistors, SMD, 0.01%, 1/16 W, 0603	Multicomp (SPC)	MCTF0603TTX1002
R7, R9	100 k Ω resistors, SMD, 1%, 1/10 W, 0603	Yageo	RC0603JR-07100KL
R8	100 k Ω resistor, SMD, 1%, 1/10 W, 0603, do not insert (DNI)	Yageo	RC0603JR-07100KL
R11	750 Ω resistor, SMD, 1%, 1/10 W, 0603, AEC-Q200	Vishay	CRCW0603750RFKEA
R10, R12	5.1 k Ω resistors, SMD, 0.1%, 1/10 W, 0603, AEC-Q200	Panasonic	ERA-3AEB512V
RF1 to RF4, RFC, RFC1, RFC2	Coaxial connectors, Subminiature Version A (SMA) right angle jack PCB	Rosenberger	32K243-40ML5
U1	IC, 32 kb serial EEPROM	Microchip Technology	24LC32A-I/MS
U8	IC, 50 mA, high voltage, micropower linear regulator	Analog Devices	ADP1720ARMZ-3.3-R7
U2	IC, 0 Hz to 18 GHz, SP4T MEMS switch	Analog Devices	ADGM1144BCCZ
Not applicable ¹	Wideband 50 Ω termination SMA loads	Pasternack	PE6081

¹ Screwed on at measurement time (see Figure 7).

**ESD Caution**

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Legal Terms and Conditions

By using the evaluation board discussed herein (together with any tools, components documentation or support materials, the "Evaluation Board"), you are agreeing to be bound by the terms and conditions set forth below ("Agreement") unless you have purchased the Evaluation Board, in which case the Analog Devices Standard Terms and Conditions of Sale shall govern. Do not use the Evaluation Board until you have read and agreed to the Agreement. Your use of the Evaluation Board shall signify your acceptance of the Agreement. This Agreement is made by and between you ("Customer") and Analog Devices, Inc. ("ADI"), with its principal place of business at One Analog Way, Wilmington, MA 01887-2356, U.S.A. Subject to the terms and conditions of the Agreement, ADI hereby grants to Customer a free, limited, personal, temporary, non-exclusive, non-sublicensable, non-transferable license to use the Evaluation Board FOR EVALUATION PURPOSES ONLY. Customer understands and agrees that the Evaluation Board is provided for the sole and exclusive purpose referenced above, and agrees not to use the Evaluation Board for any other purpose. Furthermore, the license granted is expressly made subject to the following additional limitations: Customer shall not (i) rent, lease, display, sell, transfer, assign, sublicense, or distribute the Evaluation Board; and (ii) permit any Third Party to access the Evaluation Board. As used herein, the term "Third Party" includes any entity other than ADI, Customer, their employees, affiliates and in-house consultants. The Evaluation Board is NOT sold to Customer; all rights not expressly granted herein, including ownership of the Evaluation Board, are reserved by ADI. CONFIDENTIALITY. This Agreement and the Evaluation Board shall all be considered the confidential and proprietary information of ADI. Customer may not disclose or transfer any portion of the Evaluation Board to any other party for any reason. Upon discontinuation of use of the Evaluation Board or termination of this Agreement, Customer agrees to promptly return the Evaluation Board to ADI. ADDITIONAL RESTRICTIONS. Customer may not disassemble, decompile or reverse engineer chips on the Evaluation Board. Customer shall inform ADI of any occurred damages or any modifications or alterations it makes to the Evaluation Board, including but not limited to soldering or any other activity that affects the material content of the Evaluation Board. Modifications to the Evaluation Board must comply with applicable law, including but not limited to the RoHS Directive. TERMINATION. ADI may terminate this Agreement at any time upon giving written notice to Customer. Customer agrees to return to ADI the Evaluation Board at that time. LIMITATION OF LIABILITY. THE EVALUATION BOARD PROVIDED HEREUNDER IS PROVIDED "AS IS" AND ADI MAKES NO WARRANTIES OR REPRESENTATIONS OF ANY KIND WITH RESPECT TO IT. ADI SPECIFICALLY DISCLAIMS ANY REPRESENTATIONS, ENDORSEMENTS, GUARANTEES, OR WARRANTIES, EXPRESS OR IMPLIED, RELATED TO THE EVALUATION BOARD INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, TITLE, FITNESS FOR A PARTICULAR PURPOSE OR NONINFRINGEMENT OF INTELLECTUAL PROPERTY RIGHTS. IN NO EVENT WILL ADI AND ITS LICENSORS BE LIABLE FOR ANY INCIDENTAL, SPECIAL, INDIRECT, OR CONSEQUENTIAL DAMAGES RESULTING FROM CUSTOMER'S POSSESSION OR USE OF THE EVALUATION BOARD, INCLUDING BUT NOT LIMITED TO LOST PROFITS, DELAY COSTS, LABOR COSTS OR LOSS OF GOODWILL. ADI'S TOTAL LIABILITY FROM ANY AND ALL CAUSES SHALL BE LIMITED TO THE AMOUNT OF ONE HUNDRED US DOLLARS (\$100.00). EXPORT. Customer agrees that it will not directly or indirectly export the Evaluation Board to another country, and that it will comply with all applicable United States federal laws and regulations relating to exports. GOVERNING LAW. This Agreement shall be governed by and construed in accordance with the substantive laws of the Commonwealth of Massachusetts (excluding conflict of law rules). Any legal action regarding this Agreement will be heard in the state or federal courts having jurisdiction in Suffolk County, Massachusetts, and Customer hereby submits to the personal jurisdiction and venue of such courts. The United Nations Convention on Contracts for the International Sale of Goods shall not apply to this Agreement and is expressly disclaimed. All Analog Devices products contained herein are subject to release and availability.

